

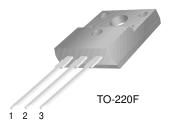
# FYPF1045DN

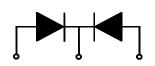
### **Features**

- · Low forward voltage drop
- High frequency properties and switching speed
- Guard ring for over-voltage protection

## **Applications**

- Switched mode power supply
- Freewheeling diodes





1. Anode 2. Cathode 3. Anode

## **SCHOTTKY BARRIER RECTIFIER**

### Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Maximum Repetitive Reverse Voltage	45	V
V <sub>R</sub>	Maximum DC Reverse Voltage	45	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 120°C	10	Α
I <sub>FSM</sub>	Non-repetitive Peak Surge Current (per diode) 60Hz Single Half-Sine Wave	80	А
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	-65 to +150	°C

### **Thermal Characteristics**

Symbol	Parameter	Value	Units
R <sub>e,IC</sub>	Maximum Thermal Resistance, Junction to Case (per diode)	4.5	°C/W

## Electrical Characteristics (per diode) T<sub>C</sub>=25 °C unless otherwise noted

Symbol	Parameter		Value	Units
V <sub>FM</sub> *		$T_{C} = 25  ^{\circ}\text{C}$ $T_{C} = 125  ^{\circ}\text{C}$ $T_{C} = 25  ^{\circ}\text{C}$ $T_{C} = 125  ^{\circ}\text{C}$	0.55 0.49 0.70	V
I	I <sub>F</sub> = 10A  Maximum Instantaneous Reverse Current	T <sub>C</sub> = 125 °C	0.65	mA
I <sub>RM</sub> *	@ rated V <sub>R</sub>	T <sub>C</sub> = 25 °C T <sub>C</sub> = 125 °C	1 40	IIIA

<sup>\*</sup> Pulse Test: Pulse Width=300µs, Duty Cycle=2%

# **Typical Characteristics**

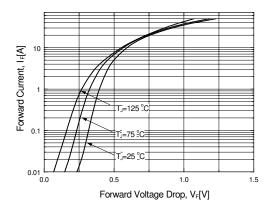


Figure 1. Typical Forward Voltage Characteristics (per diode)

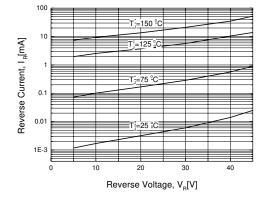


Figure 2. Typical Reverse Current vs. Reverse Voltage (per diode)

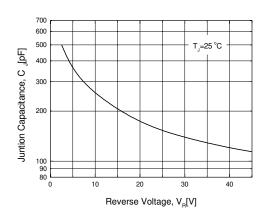


Figure 3. Typical Junction Capacitance (per diode)

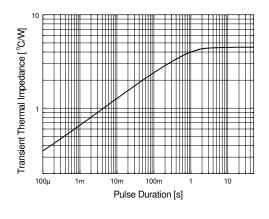


Figure 4. Thermal Impedance Characteristics (per diode)

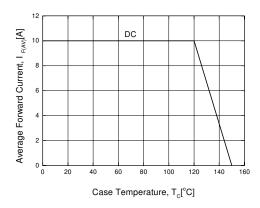


Figure 5. Forward Current Derating Curve

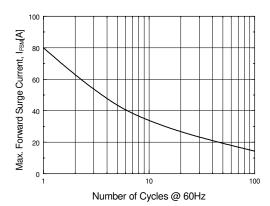
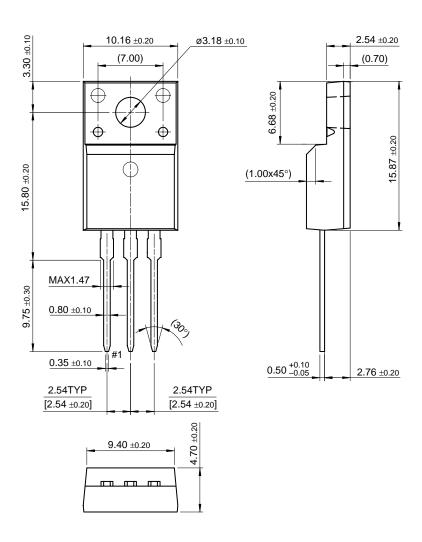


Figure 6. Non-Repetitive Surge Current (per diode)

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# **Package Dimensions**

# TO-220F



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CoolFET™	FASTr™	MicroFET™	PowerTrench <sup>®</sup>	SuperSOT™-6
CROSSVOLT™	FRFET™	MicroPak™	QFET™	SuperSOT™-8
DOME™	GlobalOptoisolator™	MICROWIRE™	QS <sup>TM</sup>	SyncFET™
EcoSPARK™	GTO™	MSX™	QT Optoelectronics™	TinyLogic™
E <sup>2</sup> CMOS™	HiSeC™	MSXPro™	Quiet Series™	TruTranslation™
EnSigna™	$I^2C^{TM}$	OCXTM	RapidConfigure™	UHC™
Across the board.	. Around the world.™	OCXPro™	RapidConnect™	UltraFET®
The Power Franc	hise™	OPTOLOGIC <sup>®</sup>	SILENT SWITCHER®	VCX™
Programmable Ad	ctive Droop™	OPTOPLANAR™	SMART START™	

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Rev. I1

### **PRODUCT STATUS DEFINITIONS**

#### **Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
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